PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
XINRUN XING	08/13/2021
SHENGQUAN HU	08/13/2021
SHENGHUI BAO	08/13/2021
JIN SU	08/13/2021
LEILI	08/13/2021

RECEIVING PARTY DATA

Name:	SHENZHEN LONTIUM SEMICONDUCTOR TECHNOLOGY CO., LTD.	
Street Address:	UNIT 01&02, 20TH FL, BLDG.19, ZHONG HAI XIN INNOVATION PARK	
Internal Address:	11 GANLI 2ND RD, JIHUA, LONGGANG DIST.	
City:	SHENZHEN, GUANGDONG	
State/Country:	CHINA	
Postal Code:	518112	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17459081

CORRESPONDENCE DATA

Fax Number: (612)332-9081

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6123325300

crogers@merchantgould.com Email: MERCHANT & GOULD P.C. **Correspondent Name:**

P.O. BOX 2903 Address Line 1:

Address Line 4: MINNEAPOLIS, MINNESOTA 55402-0903

ATTORNEY DOCKET NUMBER:	14565.0083FP01
NAME OF SUBMITTER:	TONG WU
SIGNATURE:	/Tong Wu/
DATE SIGNED:	08/27/2021

Total Attachments: 2

PATENT REEL: 057310 FRAME: 0659 source=Assignment_14565_0083FP01#page1.tif source=Assignment_14565_0083FP01#page2.tif

PATENT REEL: 057310 FRAME: 0660

INSTRUCTIONS	ASSIGNMENT TO CORPORATION	
	WHEREAS,	
Inventor(s) Name, Address, Citizenship	 Xinrun XING having an address at Bldg B3, Intelligent Equipment Tech PK, 3963 Susong Rd, Economic & Tech Zone, Hefei, Anhui 230601, P.R. China; Shengquan HU having an address at Bldg B3, Intelligent Equipment Tech PK, 3963 Susong Rd, Economic & Tech Zone, Hefei, Anhui 230601, P.R. China; Shenghui BAO having an address at Bldg B3, Intelligent Equipment Tech PK, 3963 Susong Rd, Economic & Tech Zone, Hefei, Anhui 230601, P.R. China; Jin SU having an address at Bldg B3, Intelligent Equipment Tech PK, 3963 Susong Rd, Economic & Tech Zone, Hefei, Anhui 230601, P.R. China; Lei LI having an address at Bldg B3, Intelligent Equipment Tech PK, 3963 Susong Rd, Economic & Tech Zone, Hefei, Anhui 230601, P.R. China; 	
Check the appropriate box and fill in the requested information:	COMMUNICATION and which: is the national stage application of International Application No. filed on claims priority to filed on; will be filed without this executed PATENT ASSIGNMENT. THE UNDERSIGNED hereby authorizes, and requests, ASSIGNEE'S legal representatives, of Merchant & Gould PC, who are associated with customer number 23552 to insert here in	
	parenthesis (U.S. Serial No. 17/459081 , filed August 27, 2021) this application's U.S. Serial Number and filing date, when known; was filed on and was given U.S. Serial No; or is filed concurrently herewith;	
Name of Corporation	AND SHENZHEN LONTIUM SEMICONDUCTOR TECHNOLOGY CO., LTD. (herein called "ASSIGNEE"), a corporation organized under the laws of China, and having an office and place of business at Unit 01 & 02, 20th floor, Building 19, Zhong Hai Xin Innovation Park, 11 Ganli 2nd Road, Jihua, Longgang District, Shenzhen, Guangdong \$18112, P. R. China	
State or Country of Incorporation and Address	wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor; NOW, THEREFORE, to all whom it may concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign and transfer to the ASSIGNEE, its successors and assigns, the entire right, title and interest for all	

countries in and to the invention disclosed in the aforesaid application and all the right(s) to claim priority thereto, and in and to the said application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in all countries for Letters Patent on the said invention including as assignment of all rights under the provisions of the International Convention, and all Letters Patent of all countries which may be granted therefrom; and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents to issue any and all United States Letters Patent for the aforesaid invention to the ASSIGNEE of the entire right, title and interest in and to the same, for the use of the ASSIGNEE, its successors and assigns.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to THE UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns the entire right, title and interest in and to the said invention, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE its successors and assigns, that no assignment grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by THE UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by THE UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Each inventor must sign & date Note: No legalization or other witness required

Western Co		
Name: Xinrun XING	Signature: AP · S ZZ	Date: [August 13, 202]
Name: Shengquan HU	Signature: the GV4	Date: Augus 12, 2012/
Name: Shenghui BAO	Signature: D. L. H.L.	Date: Avgrue 13, 2021
Name: Jin SU	Signature:	Date: August 13, 2021
Name: Lei Ll	Signature: 本名和	Date: August 13, Zozi